



## FEATURES

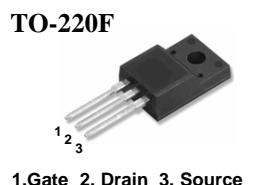
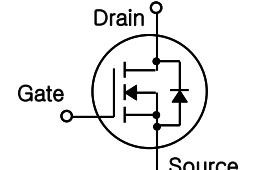
- Originative New Design
- 100% EAS Test
- Rugged Gate Oxide Technology
- Extremely Low Intrinsic Capacitances
- Remarkable Switching Characteristics
- Unequalled Gate Charge : 30 nC (Typ.)
- Extended Safe Operating Area
- Lower  $R_{DS(ON)}$  : 0.8 Ω (Typ.) @ $V_{GS}=10V$

## APPLICATION

- High current, High speed switching
- Suitable for power supplies, adaptors and PFC
- SMPS (Switched Mode Power Supplies)

# PFP10N65/PFF10N65 650V N-Channel MOSFET

**BV<sub>DSS</sub> = 650 V**  
**R<sub>DS(on)</sub> = 0.8 Ω**  
**I<sub>D</sub> = 9.5 A**



## Absolute Maximum Ratings

T<sub>C</sub>=25°C unless otherwise specified

Symbol	Parameter	PFP10N65	PFF10N65	Units
V <sub>DSS</sub>	Drain-Source Voltage	650		V
I <sub>D</sub>	Drain Current – Continuous (T <sub>C</sub> = 25 °C)	9.5	9.5*	A
	Drain Current – Continuous (T <sub>C</sub> = 100 °C)	6.0	6.0*	A
I <sub>DM</sub>	Drain Current – Pulsed (Note 1)	38	38*	A
V <sub>GS</sub>	Gate-Source Voltage	±30		V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	700		mJ
I <sub>AR</sub>	Avalanche Current (Note 1)	9.5		A
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)	15.6		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	5.5		V/ns
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25 °C)	156	50	W
	– Derate above 25 °C	1.25	0.4	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150		°C
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		°C

\* Drain current limited by maximum junction temperature

## Thermal Resistance Characteristics

Symbol	Parameter	PFP10N65	PFF10N65	Units
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	0.8	2.5	°C/W
R <sub>θCS</sub>	Thermal Resistance, Case-to-Sink	0.5	--	
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	62.5	62.5	

**Electrical Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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**On Characteristics**

$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$	2.0	--	4.0	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$ , $I_D = 4.75 \text{ A}$	--	0.8	0.98	$\Omega$

**Off Characteristics**

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	650	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.6	--	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}$ , $V_{GS} = 0 \text{ V}$	--	--	10	$\mu\text{A}$
		$V_{DS} = 520 \text{ V}$ , $T_C = 125^\circ\text{C}$	--	--	100	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}$ , $V_{DS} = 0 \text{ V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}$ , $V_{DS} = 0 \text{ V}$	--	--	-100	nA

**Dynamic Characteristics**

$C_{iss}$	Input Capacitance	$V_{DS} = 25 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1.0 \text{ MHz}$	--	1210	1580	pF
$C_{oss}$	Output Capacitance		--	145	190	pF
$C_{rss}$	Reverse Transfer Capacitance		--	16	20	pF

**Switching Characteristics**

$t_{d(on)}$	Turn-On Time	$V_{DS} = 325 \text{ V}$ , $I_D = 9.5 \text{ A}$ , $R_G = 25 \Omega$	--	20	40	ns
$t_r$	Turn-On Rise Time		--	30	60	ns
$t_{d(off)}$	Turn-Off Delay Time		--	90	180	ns
$t_f$	Turn-Off Fall Time		--	40	80	ns
$Q_g$	Total Gate Charge	$V_{DS} = 520 \text{ V}$ , $I_D = 9.5 \text{ A}$ , $V_{GS} = 10 \text{ V}$	--	30	40	nC
$Q_{gs}$	Gate-Source Charge		--	5	--	nC
$Q_{gd}$	Gate-Drain Charge		--	14	--	nC

**Source-Drain Diode Maximum Ratings and Characteristics**

$I_S$	Continuous Source-Drain Diode Forward Current	--	--	9.5	A	
$I_{SM}$	Pulsed Source-Drain Diode Forward Current	--	--	38		
$V_{SD}$	Source-Drain Diode Forward Voltage	$I_S = 9.5 \text{ A}$ , $V_{GS} = 0 \text{ V}$	--	--	1.5	V
$trr$	Reverse Recovery Time	$I_S = 9.5 \text{ A}$ , $V_{GS} = 0 \text{ V}$	--	450	--	ns
$Qrr$	Reverse Recovery Charge		$dI_F/dt = 100 \text{ A}/\mu\text{s}$ (Note 4)	--	4.2	--
						$\mu\text{C}$

**Notes :**

- Repetitive Rating : Pulse width limited by maximum junction temperature
- $I_{AS}=9.5\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
- $I_{SD}\leq 9.5\text{A}$ ,  $di/dt\leq 300\text{A}/\mu\text{s}$ ,  $V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$
- Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$
- Essentially Independent of Operating Temperature

## Typical Characteristics

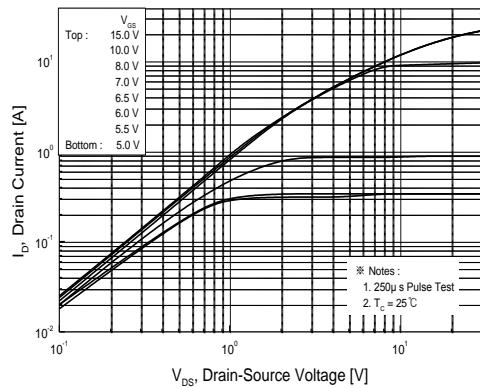


Figure 1. On Region Characteristics

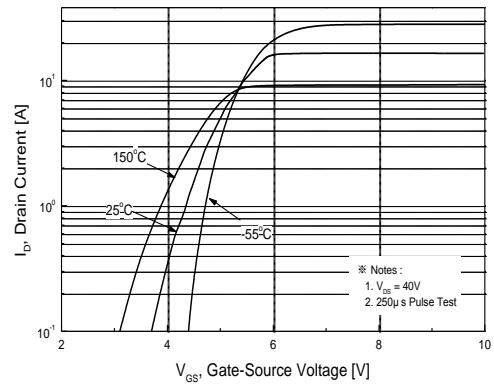


Figure 2. Transfer Characteristics

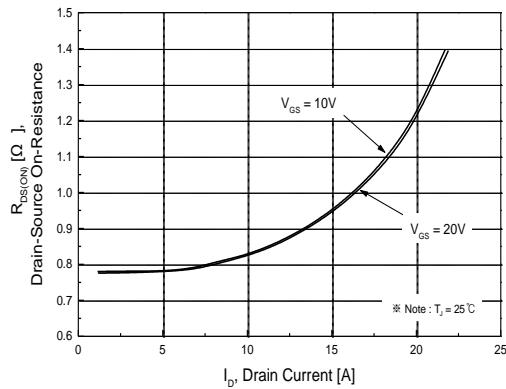


Figure 3. On Resistance Variation vs. Drain Current and Gate Voltage

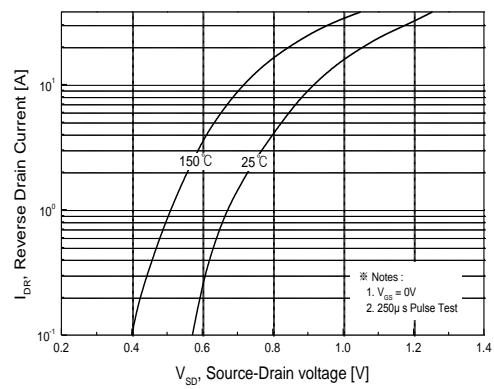


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

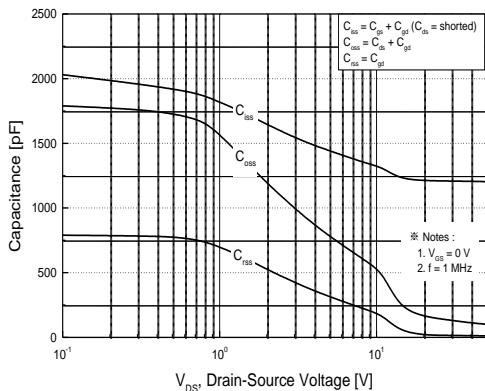


Figure 5. Capacitance Characteristics

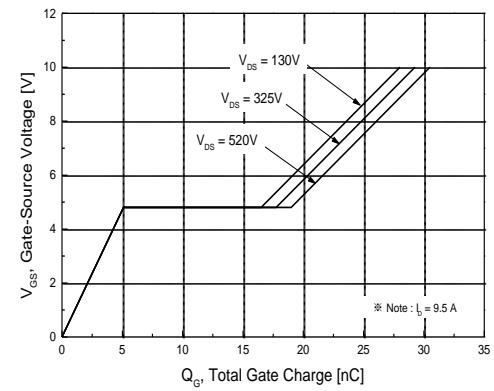
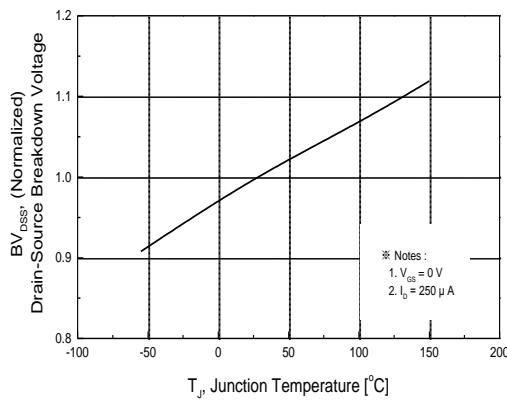
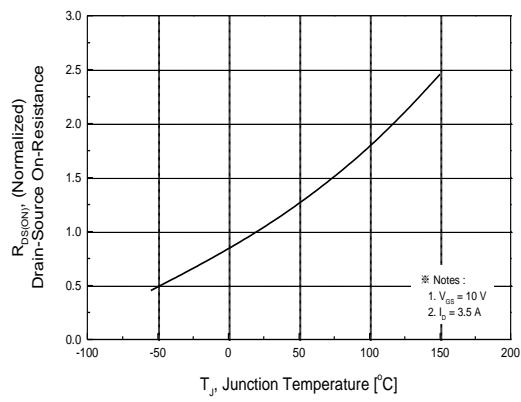


Figure 6. Gate Charge Characteristics

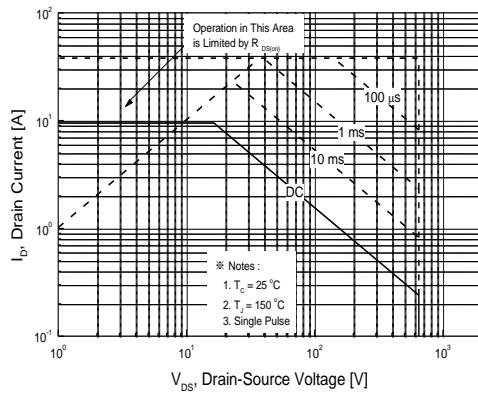
## Typical Characteristics (continued)



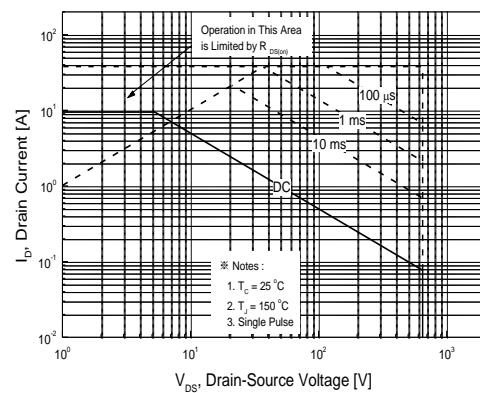
**Figure 7. Breakdown Voltage Variation vs Temperature**



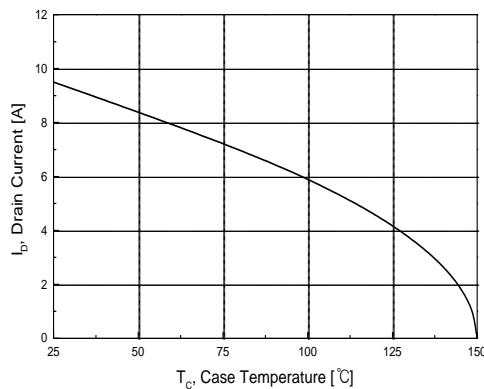
**Figure 8. On-Resistance Variation vs Temperature**



**Figure 9. Maximum Safe Operating Area for PFP10N65**



**Figure 10. Maximum Safe Operating Area for PFF10N65**



**Figure 11. Maximum Drain Current vs Case Temperature**

## Typical Characteristics (continued)

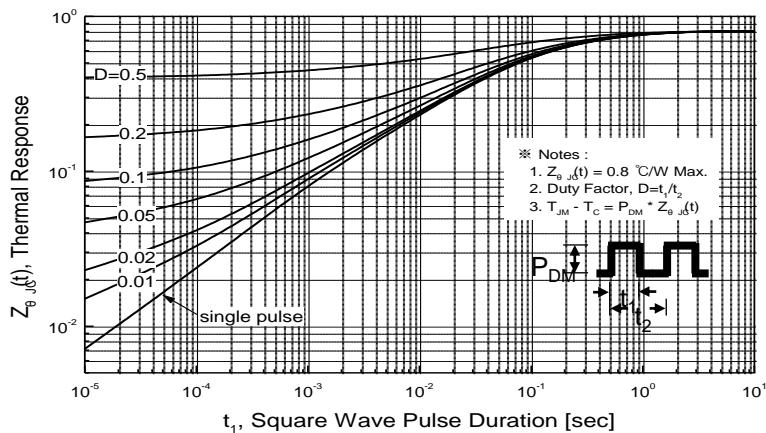


Figure 12. Transient Thermal Response Curve for PFP10N65

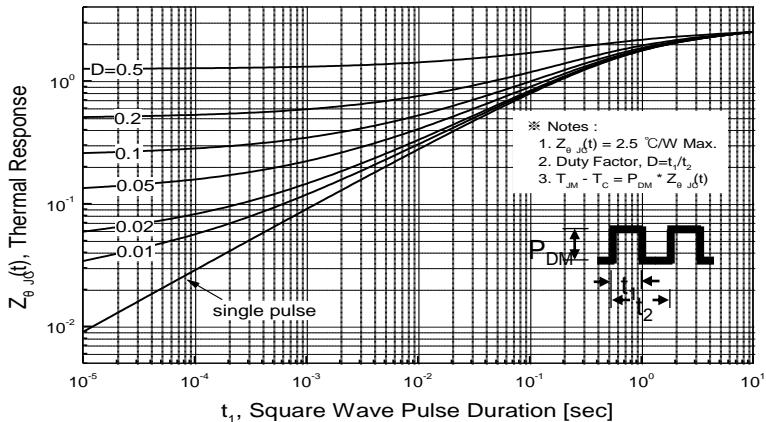


Figure 13. Transient Thermal Response Curve for PFF10N65

## Characteristics Test Circuit & Waveform

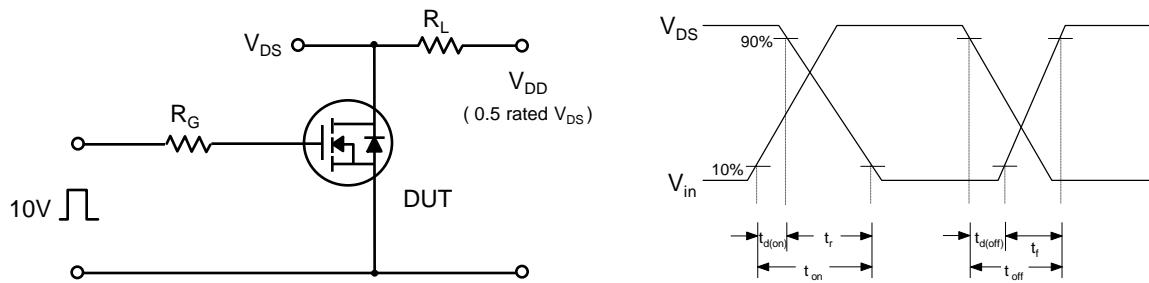


Fig 14. Resistive Switching Test Circuit & Waveforms

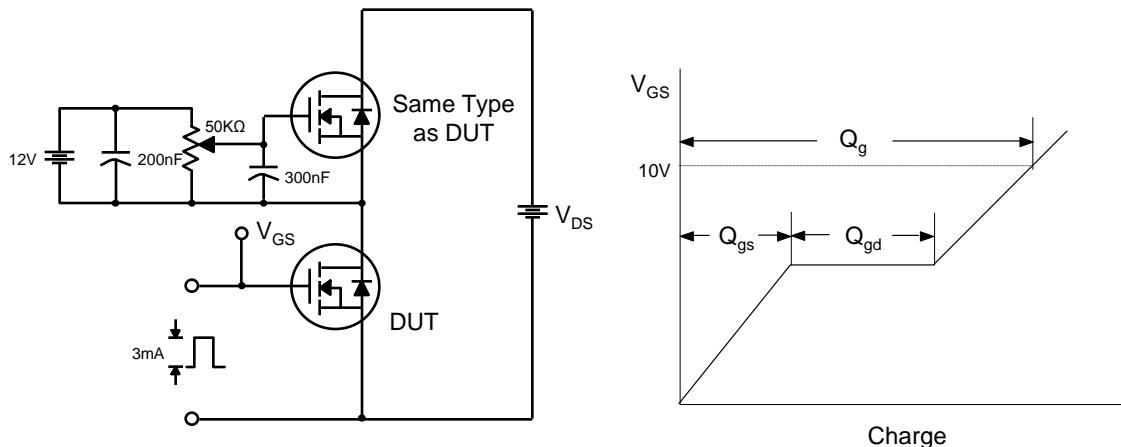


Fig 15. Gate Charge Test Circuit & Waveform

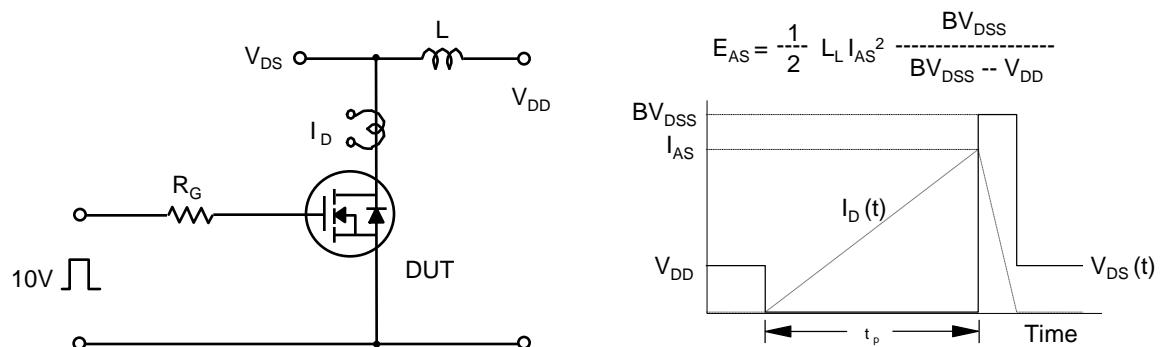


Fig 16. Unclamped Inductive Switching Test Circuit & Waveforms

## Characteristics Test Circuit & Waveform (continued)

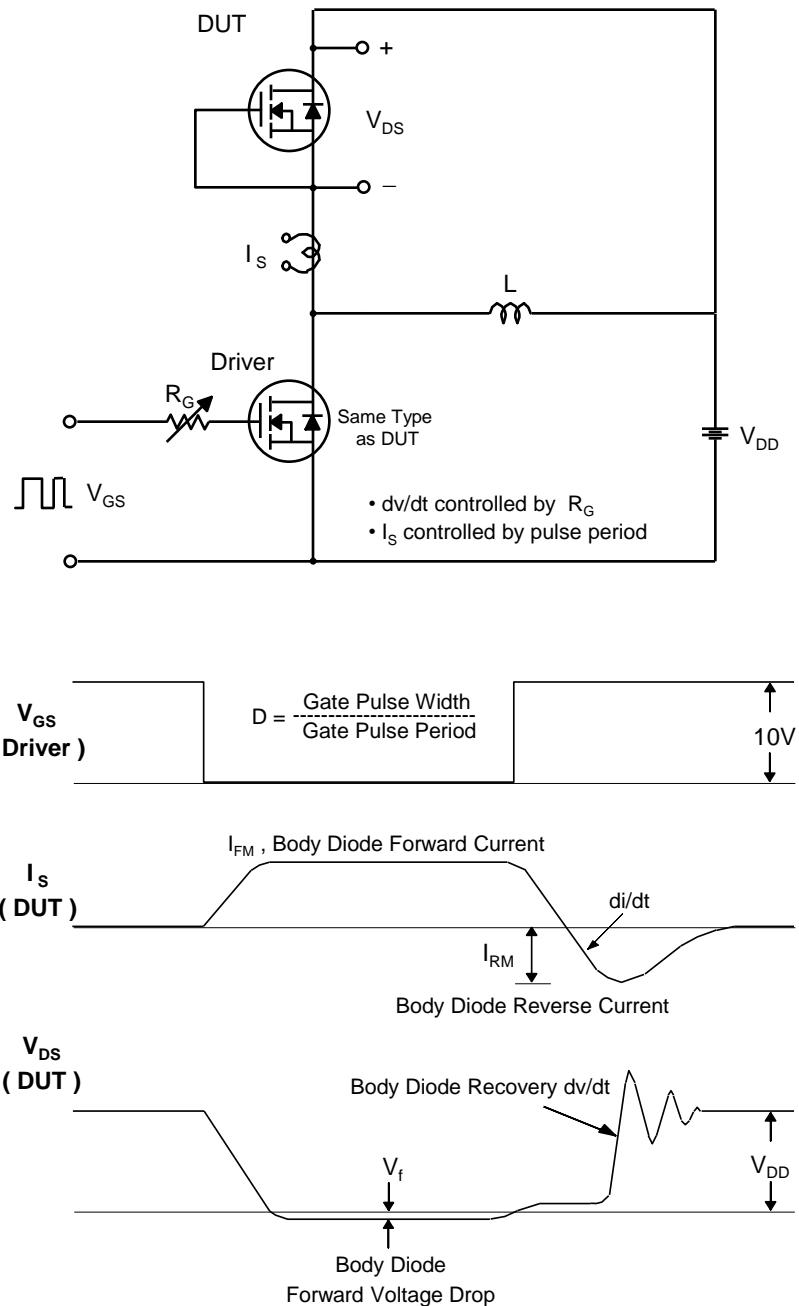
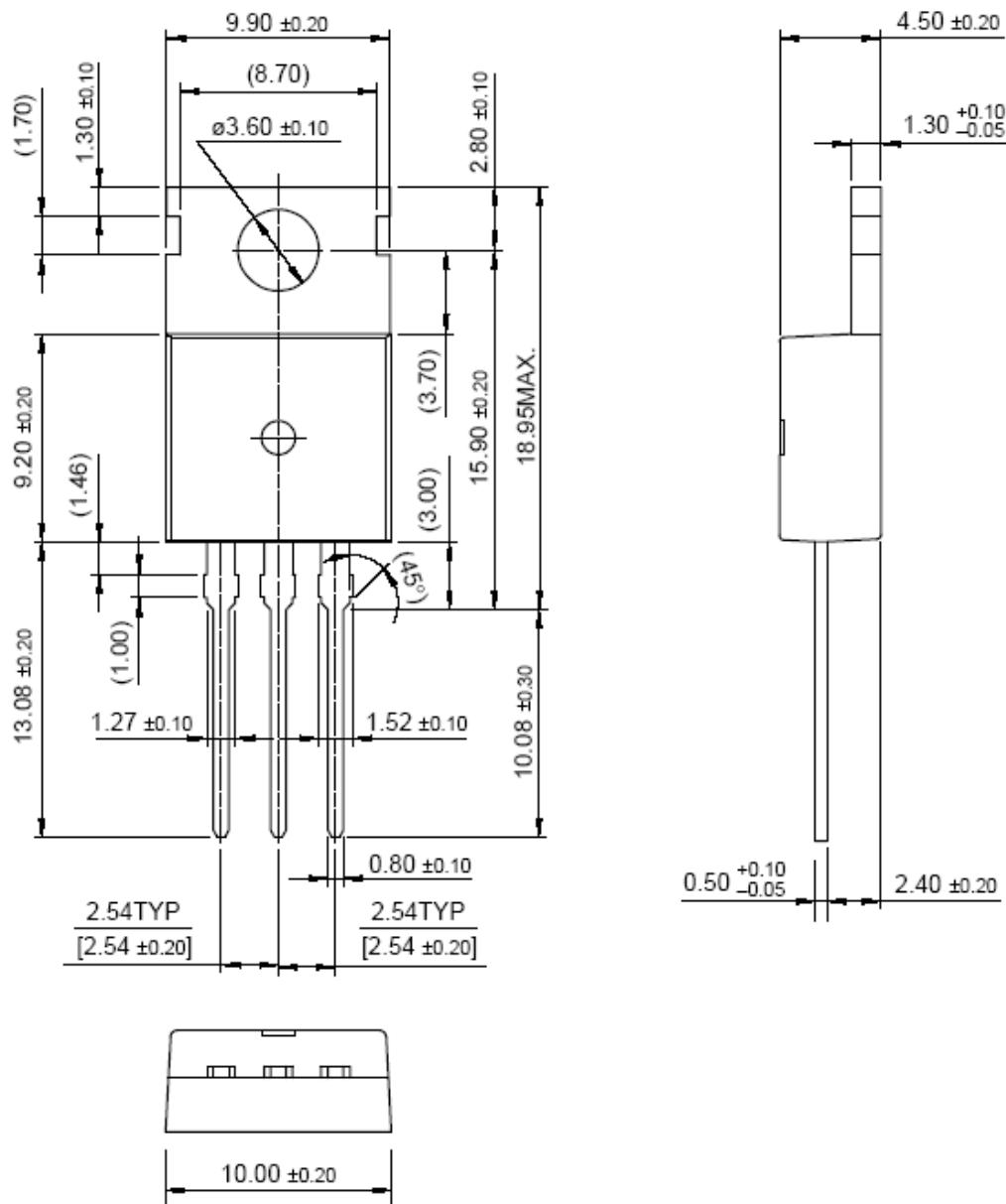
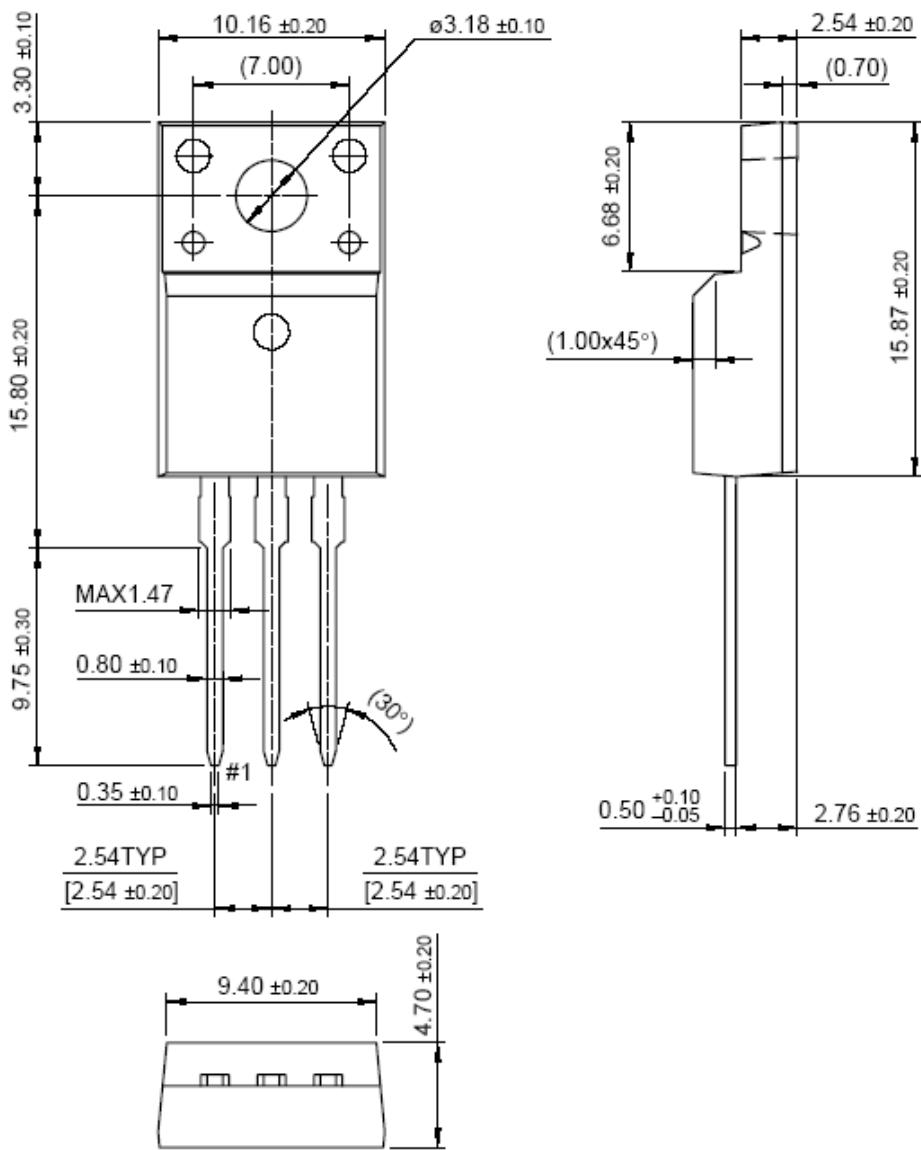


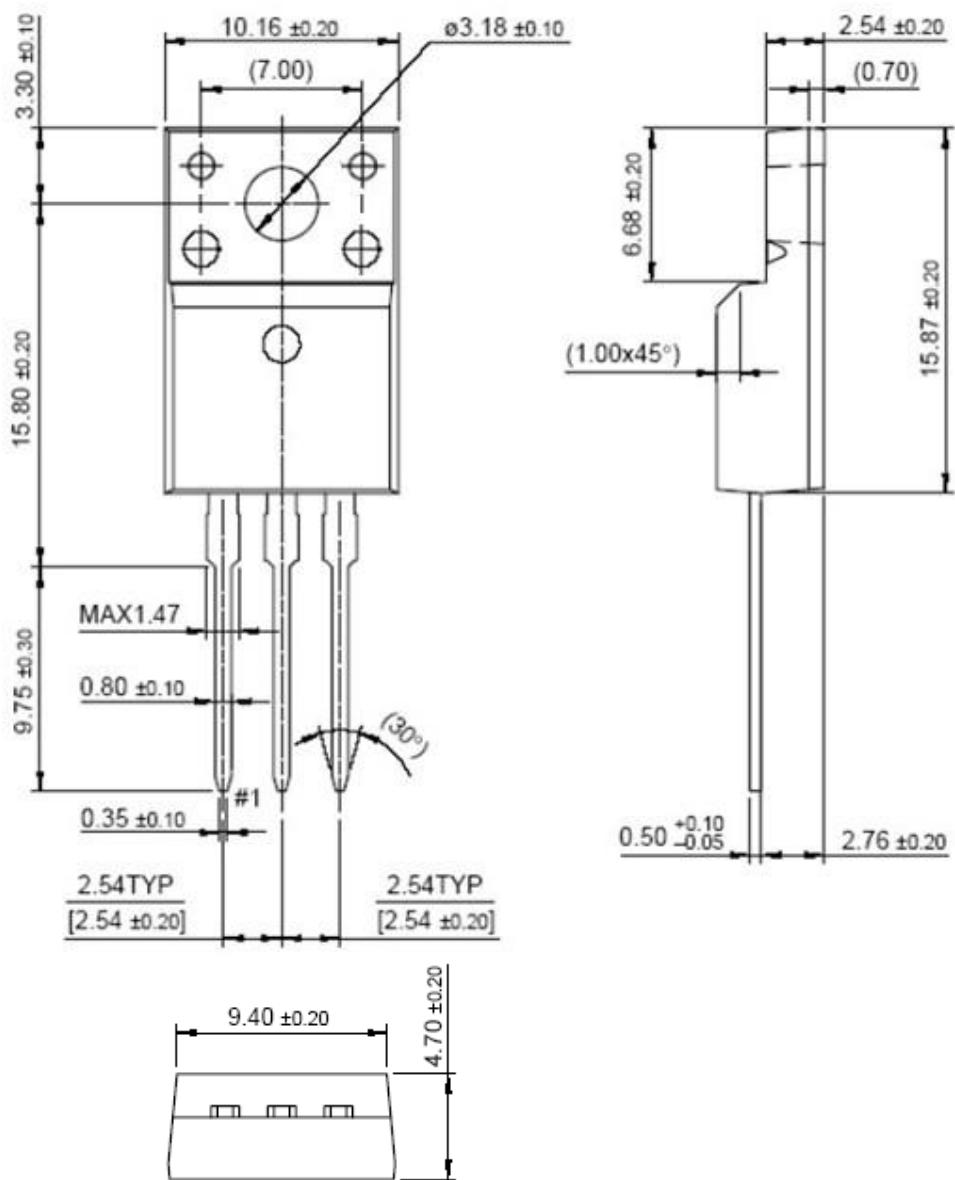
Fig 17. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms

**Package Dimension****TO-220**

**Package Dimension****TO-220F (1)**

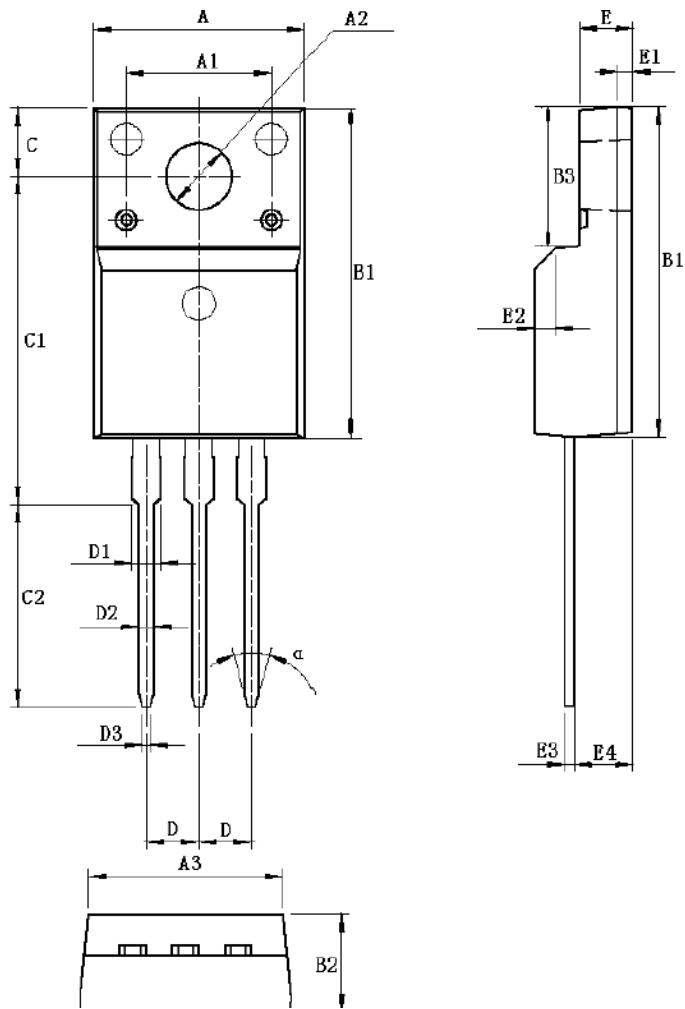
**Package Dimension**

TO-220F (2)



## Package Dimension

### TO-220F (3)



	Min	Max
A	9.96	10.36
A1	--	7.00
A2	3.08	3.28
A3	9.26	9.66
B1	15.67	16.07
B2	4.50	4.90
B3	6.48	6.88
C	3.20	3.40

	Min	Max
C1	15.60	16.00
C2	9.55	9.95
D	2.54	
D1	--	1.47
D2	0.70	0.90
D3	0.25	0.45
E	2.34	2.74
E1	0.70	

	Min	Max
E2	1.0X45°	
E3	0.45	0.60
E4	2.56	2.96
a	30°	

Unit : mm